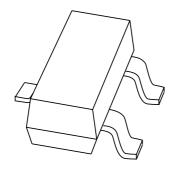
DISCRETE SEMICONDUCTORS

DATA SHEET



BC846; BC847; BC848 NPN general purpose transistors

Product specification Supersedes data of 1999 Apr 23





NPN general purpose transistors

BC846; BC847; BC848

FEATURES

• Low current (max. 100 mA)

• Low voltage (max. 65 V).

APPLICATIONS

• General purpose switching and amplification.

DESCRIPTION

NPN transistor in a SOT23 plastic package. PNP complements: BC856, BC857 and BC858.

MARKING

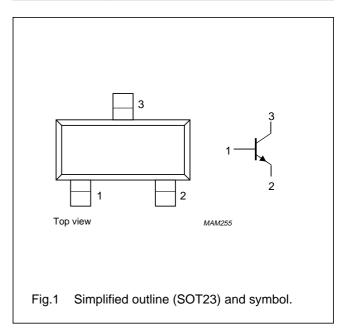
TYPE NUMBER	MARKING CODE(1)
BC846	1D*
BC846A	1A*
BC846B	1B*
BC847	1H*
BC847A	1E*
BC847B	1F*
BC847C	1G*
BC848B	1K*

Note

1. * = p: made in Hong Kong.

PINNING

PIN	DESCRIPTION	
1	base	
2	emitter	
3	collector	



^{* =} t: made in Malaysia.

NPN general purpose transistors

BC846; BC847; BC848

LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO} collector-base voltage		open emitter			
	BC846		_	80	V
	BC847		_	50	V
	BC848		_	30	V
V _{CEO}	collector-emitter voltage	open base			
	BC846		_	65	V
	BC847		_	45	V
	BC848		_	30	V
V _{EBO}	emitter-base voltage	open collector			
	BC846; BC847		_	6	V
	BC848		_	5	V
I _C	collector current (DC)		_	100	mA
I _{CM}	peak collector current		_	200	mA
I _{BM}	peak base current		_	200	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	_	250	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Note

1. Transistor mounted on an FR4 printed-circuit board, standard footprint.

THERMAL CHARACTERISTICS

SYMBOL	L PARAMETER CONDITIONS		VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	in free air; note 1	500	K/W

Note

1. Transistor mounted on an FR4 printed-circuit board, standard footprint.

NPN general purpose transistors

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CHARACTERISTICS

 T_{amb} = 25 °C; unless otherwise specified.

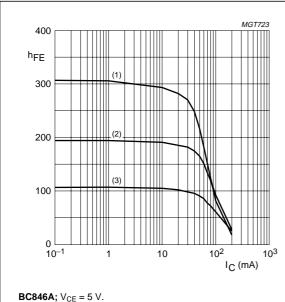
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	V _{CB} = 30 V; I _E = 0	_	_	15	nA
		$V_{CB} = 30 \text{ V}; I_{E} = 0;$ $T_{j} = 150 ^{\circ}\text{C}$	_	-	5	μΑ
I _{EBO}	emitter-base cut-off current	V _{EB} = 5 V; I _C = 0	_	Ī-	100	nA
h _{FE}	DC current gain	$I_C = 10 \mu A; V_{CE} = 5 V$				
	BC846A; BC847A		-	90	-	
	BC846B; BC847B; BC848B		_	150	-	
	BC847C		_	270	-	
	DC current gain	I _C = 2 mA; V _{CE} = 5 V				
	BC846		110	-	450	
	BC847		110	-	800	
	BC846A; BC847A		110	180	220	
	BC846B; BC847B; BC848B		200	290	450	
	BC847C		420	520	800	
V _{CEsat}	collector-emitter saturation voltage	$I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}$	_	90	250	mV
		$I_C = 100 \text{ mA}; I_B = 5 \text{ mA};$ note 1	_	200	600	mV
V _{BEsat}	base-emitter saturation voltage	$I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}$	_	700	_	mV
		$I_C = 100 \text{ mA}; I_B = 5 \text{ mA};$ note 1	_	900	_	mV
V _{BE}	base-emitter voltage	$I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V}$	580	660	700	mV
		$I_C = 10 \text{ mA}; V_{CE} = 5 \text{ V}$	_	Ī-	770	mV
C _c	collector capacitance	$V_{CB} = 10 \text{ V}; I_{E} = I_{e} = 0;$ f = 1 MHz	_	2.5	_	pF
f _T	transition frequency	$V_{CE} = 5 \text{ V}; I_{C} = 10 \text{ mA};$ f = 100 MHz	100	_	_	MHz
F	noise figure	$I_C = 200 \mu A; V_{CE} = 5 V;$ $R_S = 2 k\Omega; f = 1 kHz;$ B = 200 Hz	_	2	10	dB

Note

1. Pulse test: $t_p \le 300 \ \mu s; \ \delta \le 0.02.$

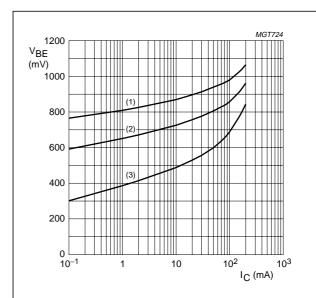
NPN general purpose transistors

BC846; BC847; BC848



- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

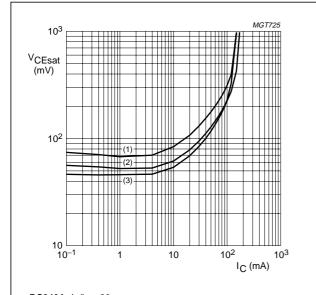
Fig.2 DC current gain as a function of collector current; typical values.



BC846A; V_{CE} = 5 V.

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

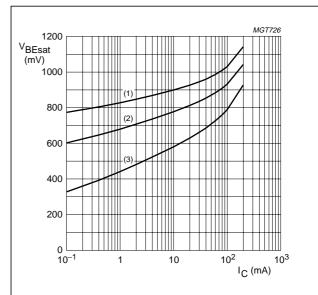
Fig.3 Base-emitter voltage as a function of collector current; typical values.



BC846A; $I_C/I_B = 20$.

- (1) T_{amb} = 150 °C.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.4 Collector-emitter saturation voltage as a function of collector current; typical values.



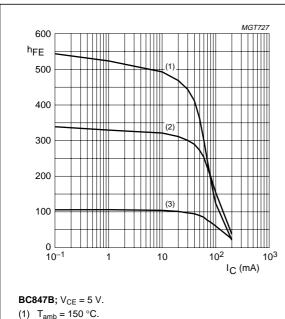
BC846A; $I_C/I_B = 10$.

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

Fig.5 Base-emitter saturation voltage as a function of collector current; typical values.

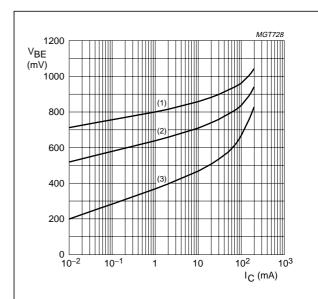
NPN general purpose transistors

BC846; BC847; BC848



- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

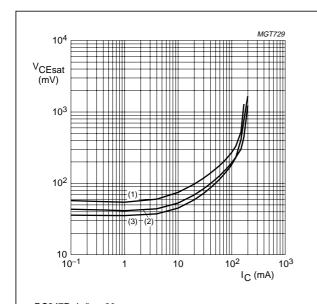
Fig.6 DC current gain as a function of collector current; typical values.



BC847B; V_{CE} = 5 V.

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

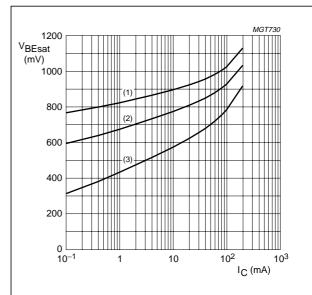
Fig.7 Base-emitter voltage as a function of collector current; typical values.



BC847B; $I_C/I_B = 20$.

- (1) T_{amb} = 150 °C.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.8 Collector-emitter saturation voltage as a function of collector current; typical values.



BC847B; $I_C/I_B = 10$.

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

Fig.9 Base-emitter saturation voltage as a function of collector current; typical values.

NPN general purpose transistors

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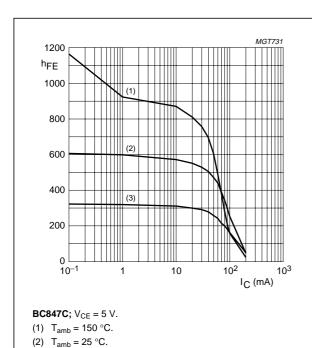
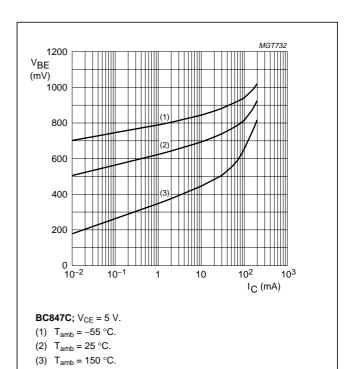
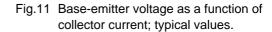


Fig.10 DC current gain as a function of collector current; typical values.

(3) $T_{amb} = -55 \, ^{\circ}C$.

(3) $T_{amb} = -55 \, ^{\circ}C$.





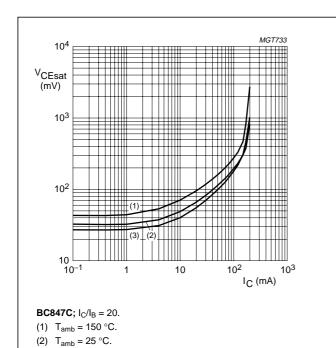
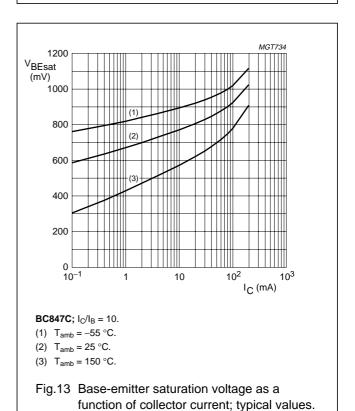


Fig.12 Collector-emitter saturation voltage as a function of collector current; typical values.



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PACKAGE OUTLINE

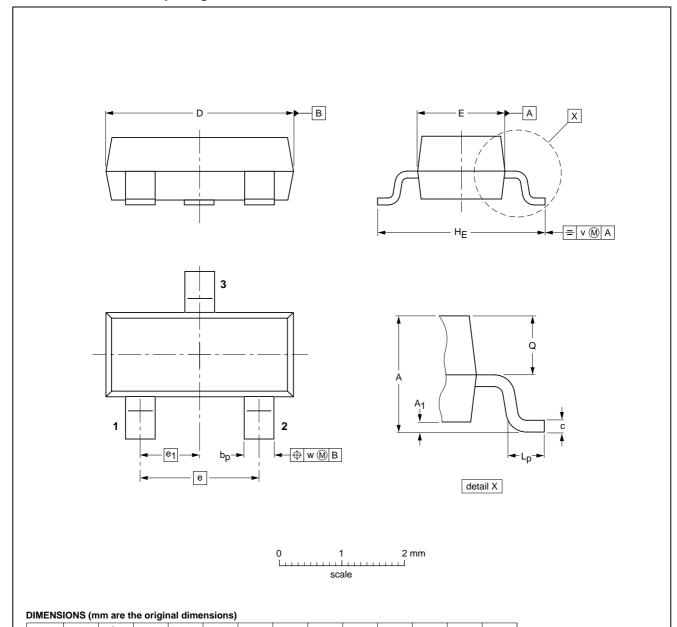
UNIT

mm

Α

Plastic surface mounted package; 3 leads

SOT23



OUTLINE		REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT23		TO-236AB				-97-02-28 99-09-13	

0.95

 H_{E}

 L_{p}

0.45 0.15 Q

0.55 0.45

0.1

2002 Feb 04 8

D

3.0 2.8

С

0.15

0.09

0.48

0.38

0.1

Ε

1.4 1.2

1.9

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NOTES

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NOTES

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